

PERSPECTIVE

Cite this: *Chem. Sci.*, 2020, **11**, 913

All publication charges for this article have been paid for by the Royal Society of Chemistry

Received 25th August 2019
Accepted 25th November 2019

DOI: 10.1039/c9sc04290c

rsc.li/chemical-science

III–V colloidal nanocrystals: control of covalent surfaces

Youngsik Kim,^{†a} Jun Hyuk Chang,^{†b} Hyekyoung Choi,^a Yong-Hyun Kim,^c Wan Ki Bae^{*d} and Sohee Jeong^{†*a}

Colloidal quantum dots (QDs) are nanosized semiconductors whose electronic features are dictated by the quantum confinement effect. The optical, electrical, and chemical properties of QDs are influenced by their dimensions and surface landscape. The surface of II–VI and IV–VI QDs has been extensively explored; however, in-depth investigations on the surface of III–V QDs are still lagging behind. This Perspective discusses the current understanding of the surface of III–V QDs, outlines deep trap states presented by surface defects, and suggests strategies to overcome challenges associated with deep traps. Lastly, we discuss a route to create well-defined facets in III–V QDs by providing a platform for surface studies and a recently reported approach in atomistic understanding of covalent III–V QD surfaces using the electron counting model with fractional dangling bonds.

1. Introduction

Colloidal quantum dots (QDs), whose photophysical properties vary depending upon their dimension, are considered to be the most promising candidates for a variety of applications

including displays,^{1,2} photovoltaics,^{3–9} and biomarkers.^{10–12} Since 10–70% of the total number of atoms reside at the exterior of nanometer sized QDs, the impact of the QD surface on its photophysical and electrical properties is substantial.¹³ Hence, understanding and controlling the QD surface has been a central theme in QD research.

^aDepartment of Energy Science and Center for Artificial Atoms, Sungkyunkwan University, Suwon-si, Gyeonggi-do 16419, Republic of Korea. E-mail: s.jeong@skku.edu

^bSchool of Chemical and Biological Engineering, Seoul National University, Seoul, Republic of Korea

^cGraduate School of Nanoscience and Technology, Department of Physics, Korea Advanced Institute of Science and Technology, Daejeon 34141, Republic of Korea

^dSKKU Advanced Institute of Nanotechnology (SAINT) and Center for Artificial Atoms, Sungkyunkwan University, Suwon-si, Gyeonggi-do 16419, Republic of Korea. E-mail: wkbae@skku.edu

[†] These authors contributed equally to this work.

Among the various binary QDs that have been explored, III–V QDs have attracted considerable attention because they do not contain toxic elements (*e.g.*, Cd or Pb) that are strictly regulated in commercial use.^{13,14} More importantly, III–V QDs are expected to exhibit unprecedented photophysical properties that cannot be easily obtained with II–VI or IV–VI QDs.^{15–18} Their relative covalent crystal bonding nature also imparts chemical robustness in polar environments.

As observed in II–VI and IV–VI QDs,^{19–23} control over the surface of III–V QDs is prerequisite to fully exploit them in



Youngsik Kim is a PhD student at the Department of Energy Science, Sungkyunkwan University in South Korea. His research interests include the synthesis and surface chemistry of quantum confined nanocrystals for use in light emitting diodes and photovoltaics.



Jun Hyuk Chang is a PhD candidate at Seoul National University, South Korea. He received a B.S. degree in 2015 from the same university. His research interests include the synthesis and characterization of nanocrystal quantum dots for use in light-emitting diodes.



optoelectronic applications. The ability to accurately implement the bandgap²⁴ and display tunable electronic energy level positions^{8,25,26} through modulation of particle size and surface ligands, respectively, are requisite characteristics of high performance III–V QDs. Exciton dynamics can also be engineered into the QDs by controlling the shape or heterostructure formation. This can be achieved by controlling the reactivity of precursors or the synthesis process to enable diffusion-controlled growth.^{14,34–37}

Herein, we present perspectives of research on III–V QDs focusing on their surface properties (Fig. 1). Specifically, in regard to studies on surface chemistry for high performance III–V QDs, we discuss the challenges in achieving ideal optoelectronic properties that originate from un-controlled covalent III–V QD surfaces, such as the deep trap states caused by surface defects.^{38,39} Then, approaches on eliminating deep trap states, including semiconducting shell growth over the core⁴⁰ surface etching of dangling atoms,⁴¹ and post-synthetic ligand passivation,^{42,43} are reviewed. The size-dependent faceted QD model and related facet-dependent surface chemistry that are well

established in IV–VI QDs are revisited to facilitate an understanding of the surface properties of III–V QDs. Finally, the electron counting model with fractional dangling bonds⁴⁴ is introduced as a tool to view the surface of III–V QDs in atomistic detail.

2. Characteristics and challenges of III–V QDs

Lattice covalency can be evaluated using Phillips ionicity (f), which represents the quantified values of the chemical bonding tendency between ionic and covalent bonding. Generally, III–V semiconductors have a smaller Phillips ionicity, and thus they have relatively larger lattice covalency (e.g., f of InP and CdS equals 0.421 and 0.685, respectively).^{30,45} This lattice covalency of III–V materials affects various physical and chemical properties. For example, covalent-bonding characteristics, representing delocalization of electron wavefunction across constituent chemical elements, give rise to a smaller effective mass of the electrons (m_e^*) and a larger dielectric constant of the



Hyekyoun Choi is a research professor at the Department of Energy Science, Sungkyunkwan University (SKKU). She received her PhD in Nanomechatronics from the University of Science and Technology (UST) in South Korea in 2017. Her research interests include synthesis and surface chemistry of colloidal nanocrystals for high performance opto-electronic devices.



Wan Ki Bae is an assistant professor at SAINT, Sungkyunkwan University (SKKU). He received his B.S., M.S., and PhD Chemical and Biological Engineering degrees from Seoul National University (SNU) in South Korea in 2003, 2005, and 2009, respectively. He conducted postdoctoral study at Los Alamos National Laboratory in 2010–2013 and was a senior researcher at the Korea Institute of Science and Technology (KIST) in 2013–2018 before he joined the faculty of SKKU in 2018.



His current research projects are associated with computational materials physics for energy storage and utilization.

Prof. Yong-Hyun Kim is currently a tenured professor at the Graduate School of Nanoscience and Technology and the Department of Physics, KAIST. He received his B.S. (1997), M.S. (1999), and PhD (2003) from the Department of Physics, KAIST and worked for National Renewable Energy Laboratory, Golden, Colorado, USA as a post-doc and regular staff scientist from 2003 to 2009.



Her current research interests include the microscopic understanding of the surface chemistry of nanocrystal quantum dots, specifically aiming at efficient charge transfer for quantum-dot-based applications, including photovoltaics.

Sohee Jeong is currently an associate professor at the Department of Energy Science of Sungkyunkwan University (SKKU). Before joining SKKU, she was a principal researcher at the Korea Institute of Machinery and Materials (KIMM). She obtained her B.S. and M.S. Chemistry degrees from the Korea Advanced Institute of Science and Technology (KAIST) and her PhD Chemistry degree from the

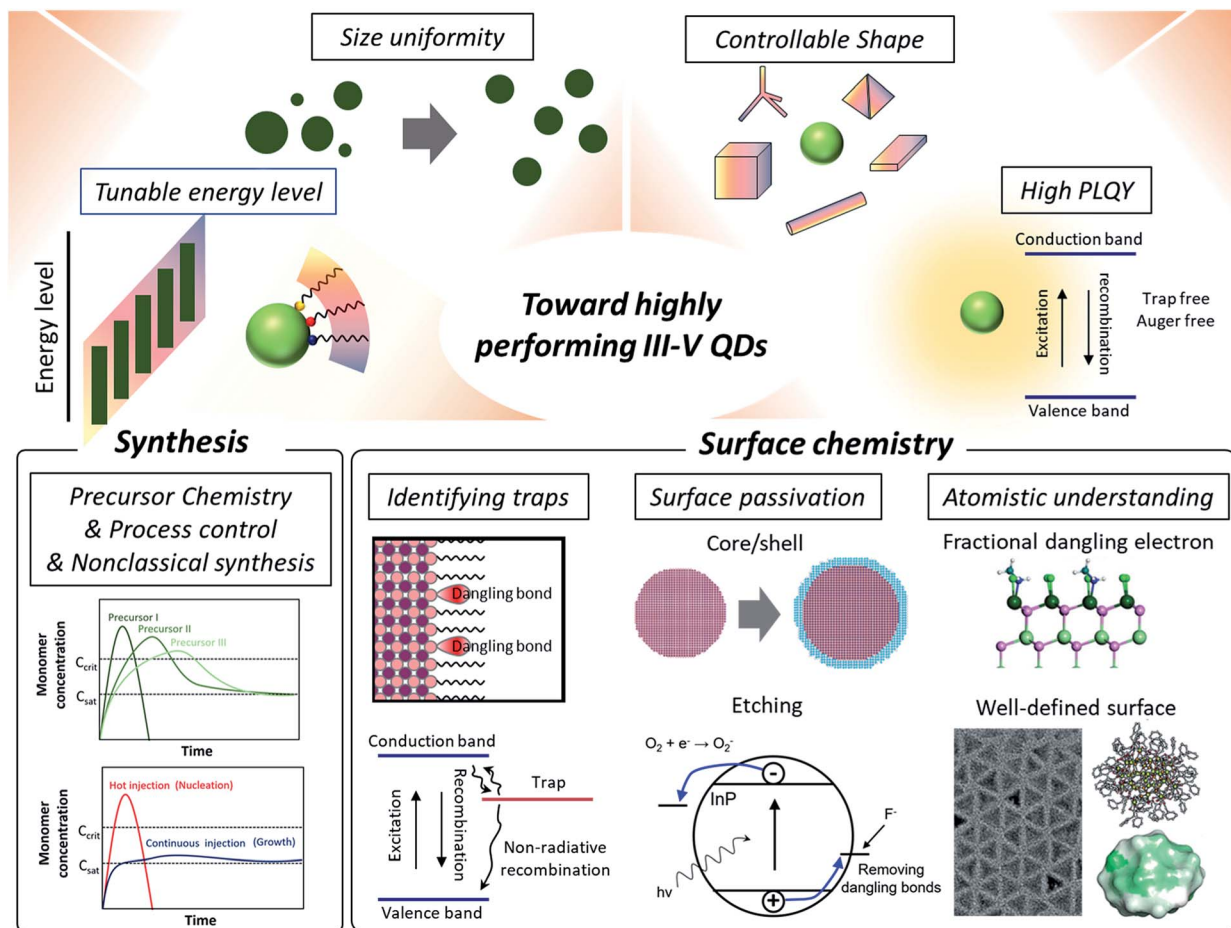


Fig. 1 Towards high performance III–V QDs. High performance QDs require tunable energy levels, size uniformity, controllable shape, and high photoluminescence quantum yields. Synthetic approaches include developing new molecular precursors with controlled reactivity or processing control for induced focusing during the growth. Non-classical growth mechanisms are currently being explored for better control of III–V QD synthesis. In regard to surface chemistry, which is the focus of this perspective, research on identifying the origin of trap states is reviewed. Two prevailing ways to passivate surface traps of III–V QDs are removing dangling bonds *via* a core/shell approach and etching. Having an atomistic surface structure of III–V QDs using synthetic design and density functional theory (DFT) based surface energy calculations is beneficial for developing precisely controlled passivation approaches, as evidenced from IV–VI QDs. The atomistic description of fractional dangling electrons is reproduced with permission from ref. 44. Copyright 2017 Royal Society of Chemistry. The TEM image of tetrahedron shaped InP nanocrystals is reproduced with permission from ref. 88. Copyright 2016 Wiley Online Library. The molecular structure of InP nanoclusters which have a well-defined number of atoms with their surface energy map is reproduced with permission from ref. 85 and 86. Copyright 2016, 2018 American Chemical Society.

materials.³⁸ Table 1 lists the basic parameters of representative bulk III–V semiconductors. On account of their electronic properties^{27,29,30,46} with robustness under electric or environmental stress that cannot be addressed easily with II–VI or IV–VI semiconductors, III–V semiconductors are widely used in optoelectronic applications.

For instance, GaN enables stable and efficient blue light-emitting diodes,⁴⁷ and GaAs enables the highest efficiency single-junction solar cells (29.1% according to the NREL chart, 2019).⁴⁸ However, the excellent properties that are prevalent in bulk III–V semiconductors rarely appear in colloidal QDs, mainly due to the difficulty in controlling the colloidal synthesis and the surface properties of III–V QDs.³⁸ Typically, epitaxial growth of III–V crystals (*e.g.*, GaAs, InP, and GaSb) requires reaction temperatures ranging from 520 to 800 °C, which is

much higher than the temperature that is required for II–VI materials (250–450 °C).⁴⁹ To grow III–V crystals in solution, the use of highly reactive precursors that constrain the process window for QD synthesis is inevitable.^{38,45} There have been numerous attempts to find suitable precursor reactivities and process conditions based on classical and non-classical nucleation and growth models.^{14,50,51} Synthesis using a metal-carboxylate ligand and tris(trimethylsilyl)pnictogen ((TMS)₃V) as the precursor is most widely explored for III–V QD synthesis as thoroughly covered in great detail in several reviews.^{14,45,52–54} The defects that rarely appear in ionic-bonding compound QDs should be considered for III–V QDs with a strong covalent lattice. In addition to the synthetic challenges of high quality III–V QDs, passivation of the surface is another, yet more critical, issue.^{38,39,41} The electronic energy level of trap states that

Table 1 Basic parameters of III–V bulk materials

Material ^a	GaP	GaAs	GaSb	InP	InAs	InSb
Bandgap type ^f	Indirect	Direct	Direct	Direct	Direct	Direct
Ionicity (Philips) ^g	0.374	0.31	0.261	0.421	0.357	0.321
Ionicity (Pauling) ^g	0.27	0.26	0.26	0.26	0.26	0.25
Effective mass of electron (m_e/m_0) ^{b,f}	0.21 ^e	0.067	0.042	0.077	0.023	0.014
Effective mass of light hole (m_{lh}/m_0) ^{b,f}	0.17 ^e	0.082	0.047	0.12	0.026	0.021
Effective mass of heavy hole (m_{hh}/m_0) ^{b,f}	0.67 ^e	0.45	0.26	0.56	0.35	0.45
Bandgap at 300 K (eV) ^f	2.272	1.424	0.725	1.344	0.356	0.180
Lattice constant (Å) ^e	5.45	5.65	6.09 ⁱ	5.86	6.05	6.47
Exciton Bohr radius (nm) ^c	7.3 ^e	11.5	23.4	9.8	35.9	61.7
Electron mobility (cm ² V ⁻¹ s ⁻¹) at 300 K ^{d,f}	190	9750	7700	5400	33 000	77 000
Hole mobility (cm ² V ⁻¹ s ⁻¹) at 300 K ^{d,f}	150	450	1000	150	450	850
Dielectric constant ^f	10.7 ^h	12.6	15.7	12.4	14.6	15.7 ^j

^a All materials are zinc blende structures. ^b Mass values are obtained by cyclotron resonance.²⁷ ^c Exciton Bohr radius, a_{exc} , is calculated using $a_{\text{exc}} = \frac{a_{\text{B}} \times k}{m_{\text{T}}/m_0}$ ref. 28. a_{B} is the Bohr radius of the hydrogen atom, k is the dielectric constant of the material, m_{T} is the reduced effective mass, and m_0 is the free electron mass. ^d The mobility values at 300 K are obtained under clean conditions, so that the impurities and structural defects influence their mobility. ^e Ref. 29. ^f Ref. 27. ^g Ref. 30. ^h Ref. 31. ⁱ Ref. 32. ^j Ref. 33.

originate from broken bonds at the surface atoms of III–V QDs resides much deeper when compared with the case of ionic-bonding characteristics.^{38,55} Heath and Shiang demonstrated that the surface trap energies of similarly sized QDs are significantly different for CdSe and InP QDs (0.25 and 6.3 kJ mol⁻¹ for 30 Å CdSe and InP QDs, respectively).³⁸ To identify the origin of deep trap states, Fu *et al.* calculated the trap states of InP QDs *via* the semi-empirical pseudopotential method.³⁹ According to their calculations, InP QDs do not hold trap states inside the bandgap when their surfaces are completely passivated. In other words, the deep trap states in the bandgap originate from surface defects. When the particle size of InP QDs is 4 nm, the trap depth of the P dangling bond and the valence band edge is 0.42 eV, while the trap depth of the In dangling bond and the conduction band edge is relatively small value of 0.08 eV (Fig. 2a and b), indicating that the P dangling bond in InP QDs is responsible for deep trap states. More recently, based on cluster model calculations that exclude one-dimensional confinement errors,⁵⁶ the indium dangling bond has been considered to be responsible for deep trap states, especially in QDs with small particle sizes. Indium and phosphorous dangling bonds generate deep trap states at -3.947 eV and shallow trap states at -5.717 eV, respectively. Note that in the case of InP QDs, the conduction band edge energy level is affected to a greater extent than the valence band edge energy level upon variation of the QD volume, following their respective effective mass.^{56,57} Therefore, electron trap energies become greater for smaller InP QDs.⁵⁶ Additionally, in the case of GaAs QDs, the structural defect of a Ga vacancy and lattice disorder is speculated to be responsible for their indirect-like optical properties.⁵⁸ Structural defects that barely appear in ionic-bonding compound QDs should be taken into account for III–V QDs with a strong covalent lattice.

In addition, III–V QDs suffer from severe oxidation upon exposure to any oxygen sources, owing to the high oxophilicity of elements in groups III and V.^{59–61} Although the effect of surface oxidation on the optical properties of III–V QDs is still

largely un-explored, it is apparent that the oxidized surface obscures atomistic surface investigations. An oxidation-free surface will certainly facilitate a greater understanding of the surface of III–V QDs.

Approaches to passivate the surface of III–V QDs, such as inorganic shelling on the core and etching off the dangling bonds, are discussed in the next section.

3. Surface passivation

3.1 Core/shell formation

Growing inorganic layers with similar crystal structures is the most prevalent strategy to passivate the surface defects of QDs. Inorganic passivation layers with a larger bandgap spatially decouple the electron and hole wavefunctions sitting at the core from the surface trap states, leading to the enhancement of both luminescence efficiency and photochemical stability of QDs. Initially, the heterostructured QDs started from a rather simple architecture (*e.g.*, CdSe/ZnS⁶²) and have evolved to equip with more complex architectures.

The state-of-the-art heterostructured QDs retain delicately engineered thick shells to mitigate structural stresses between the core and shell materials (*e.g.*, multiple alloy or composition gradient shells) for high luminescence efficiency even under thermal stresses or electrical fields.^{63–66}

The protocol for core/shell heterostructuring, which has been successfully employed in QDs with ionic bonding characteristics, has been applied to III–V QDs.^{67–69} The first demonstration was a InP/ZnS core/shell heterostructure.⁷⁰ The growth of a thin ZnS layer (~1 nm) effectively passivates the surface trap states on the InP surface, enabling a high luminescence efficiency (photoluminescence quantum yield ((PLQY) ~70%).⁷¹ Later, a ZnSe interlayer was adopted to mitigate the lattice mismatch between the InP core and ZnS exterior layer.⁷² The thick ZnSe/ZnS multi-shell that effectively confines charge carriers within the InP core permits higher PL QY (~80%) and improved photochemical stability.^{68,73} Recently, a design

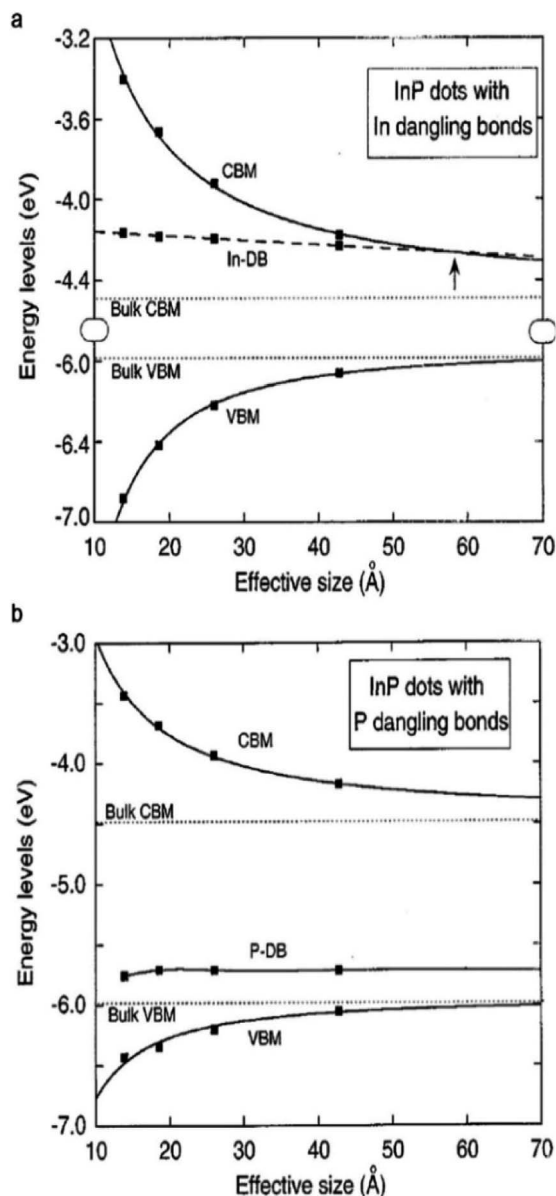


Fig. 2 Energy level of (a) indium dangling bonds (DB), size dependent conduction band minimum (CBM), and valence band maximum (VBM) of InP QDs. The arrow indicates the size for which the energy state of the dangling bond appears. (b) P dangling bonds in InP QDs. Reproduced with permission from ref. 39. Copyright 1997 The American Physics Society.

principle for the $\text{ZnSe}_x\text{S}_{1-x}$ shell that depends upon the size of the InP core was proposed.⁷⁴ The optimal composition for the $\text{ZnSe}_x\text{S}_{1-x}$ alloy layer at the interface between InP and ZnS was thoroughly investigated after consideration of effective electron confinement into InP QDs and the mitigation of lattice mismatch with InP QDs (Fig. 3a and b).

Even with the introduction of shells, III-V QDs still exhibit inferior optical properties compared to II-VI QDs. The charge imbalance that inherently exists at the interface between the III-V core and II-VI shell creates an internal trap state that is responsible for the PLQY loss of QDs. As evidenced from the

success in II-VI monovalent core/shell QDs, we believe that the growth of III-V shell materials may greatly enhance the optical properties of III-V QDs. Further atomistic details on III-V QDs and their interfaces will provide a pathway to heterostructures that enable engineered exciton dynamics.

3.2 Etching of surface defects

In parallel with the core/shell heterostructuring, alternative chemical means that remove surface dangling bonds or oxidation layers have been explored (summarized in Table 2).^{8,41,75,76} The first attempt was performed by Olga I. Micic *et al.*,⁷⁷ who observed strong band-edge emissions from InP QDs when exposed to dilute solutions of HF or NH_4F . The fluoride chemicals eliminate (passivate) the surface deep states of InP QDs, reflected as the suppression of parasitic emission at lower energies with a long recombination lifetime (>500 ns). Later, D. V. Talapin *et al.* unveiled the surface etching of InP QDs with HF caused by the migration of photoexcited charge carriers to the P dangling bonds (Fig. 4a).⁷⁵ Recently, milder etchants (*e.g.*, 1-hexyl-3-methyl-imidazolium tetrafluoroborate (BF_4)⁷⁶) have been researched. The strategy that has been validated in InP QDs has also been applied to InAs QDs.⁷⁸ Recently, S. Jeong *et al.* reported that nitrosyl tetrafluoroborate (NOBF_4) is effective in removing not only the surface dangling bonds and native ligands, but also the amorphous oxides grown on InAs QDs (Fig. 4b and c).⁸

Additionally, surface ligands can treat the traps for passivation after the synthesis. However, surface passivation using surface ligands after the synthesis is considered less effective in III-V nanocrystals when compared with II-VI or IV-VI nanocrystals because of the covalency in surface dangling bonds. Recently, the use of Z-type surface ligands for deep trap passivation has been demonstrated in InP nanocrystals with the PL efficiency increase of 10–50%.^{42,43} A more in-depth understanding of the surface is required for more precise passivation procedures. In the next section, we will discuss atomistic surface models of III-V QDs.

4. Atomistic understanding of the surface

4.1 Lessons learned from ionic QDs

For simplicity's sake, QDs are often considered to be spherical in shape with facet-independent surface characteristics. However, QDs are actually composed of various crystal facets that display different physical and chemical properties.^{19,79} Each crystal facet provides distinctive stoichiometry, and thus different chemical reactivities. Facet-specific surface chemistry of the ionic IV-VI QDs is well understood.^{19–23} For lead chalcogenide QDs, the crystal facets exposed on the surfaces consist of non-polar (100) and polar (111) facets. Atomistic surface understanding unveiled the origin of the size-dependent air-stability in lead chalcogenide QDs (Fig. 5a). Polar (111) facets exposing Pb atoms are fully passivated with oleate ligands, which results in complete passivation. By contrast, the stoichiometric (100) surfaces are self-passivated by Pb and

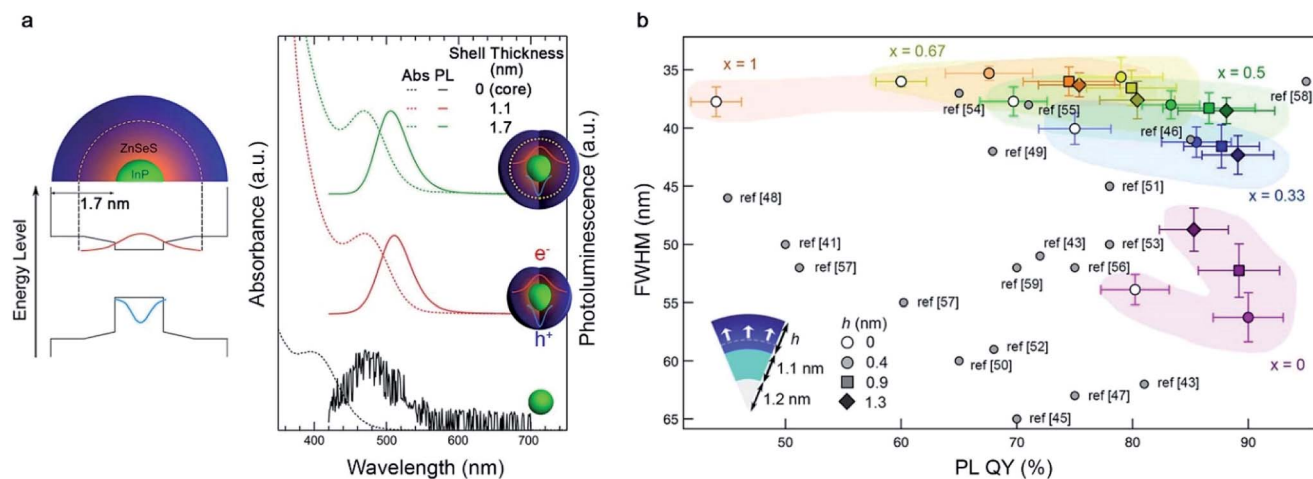


Fig. 3 The core/shell approach for surface passivation. (a) Illustration of the InP/ZnSeS structure (left) and absorption and PL spectrum of InP and InP/ZnSeS (right), reproduced with permission from ref. 68. Copyright 2013 American Chemical Society (b) recently proposed design protocol for InP/ZnSe_xS_{1-x}/ZnS. Reproduced with permission from ref. 74. Copyright 2019 American Chemical Society.

chalcogenide (S, Se and Te) bonds without organic ligands, making them prone to oxidation.¹⁹ PbS QDs with a diameter below 4 nm that have surfaces terminated with only (111) facets are air-stable. However, PbS QDs with a diameter above 4 nm, on which the (100) facets emerge, are easily oxidized under air-exposure.¹⁹ In order to passivate the (100) facets, Woo *et al.* performed an *in situ* post-synthetic halide salt treatment on the PbSe QDs (Fig. 5b).²⁰ This imparts size-independent air-stability and a higher PLQY, owing to the formation of a PbX₂ (X = Cl, Br, I) adlayer on the (100) surface (Fig. 5c).

Based on facet change according to the particle size, it is possible to predict the facet of PbS QDs at a certain size and to design specific surface passivation or ligand exchange according to the predicted facet. The PbS QD atomistic surface model allows a better chemical treatment procedure for fabrication of PbS QD films with a desired energy level, carrier concentration,

doping polarity, *etc.*, leading to technological leaps in PbS QD solar cell research.^{3,80,81} Additionally, by leveraging the different surface energies of a specific facet, one can synthesize the extended structure of PbS nanosheets.⁸²

Similarly, a deeper understanding of the III-V QD surface is expected to not only make significant improvements on surface passivation techniques, but also provide a method to tune energy levels with controlled surfaces or realizing extended structures.

4.2 Electron counting model with fractional dangling bonds in III-V QDs

It is particularly difficult to visualize the faceted surfaces of QDs with a very small size ranging around 1–10 nm. Therefore, the first-principles calculation or simulation can be a powerful tool to model the surface. To elucidate the surface of III-V QDs, Ko

Table 2 Surface passivation of InP or InAs QDs using etchants

QD material	Etchants	Ligands	Etching condition	Result	Ref.
InP	HF, NH ₄ F, N(C ₄ H ₉) ₄ F·3H ₂ O, pyridine poly(hydrogen fluoride), HF-melamine complexes	TOPO or dodecanethiol	Photochemical etching with 450 W Xe lamp	PL QY 20–40%	75
	KF, [18-crown-6] complex, hexadecylamine hydrofluoride			PL QY 3–5%	
InP	HF	TOPO with TOP	Photochemical etching with 450 W Xe lamp	PL QY 20–40%	41
InP	1-Hexyl-3-methyl-imidazolium BF ₄ , 1-butyl-4-methyl-pyridinium BF ₄	Palmitate	Microwave synthesis	PL QY 1–47%	76
	1-Hexyl-3-methyl-imidazolium PF ₆			PL QY 1–24%	
	Tetrabutylammonium BF ₄			PL QY 1–11%	
	1-Butyl-4-methyl-pyridinium PF ₆ , tetrabutylammonium PF ₆ , tetrabutylammonium fluoride, 1-hexyl-3-methyl-imidazolium Cl, 1-butyl-4-methyl-pyridinium Cl			PL QY below 3%	
InAs	Nitrosyl tetrafluoroborate (NOBF ₄)	Oleic acid	Chemical etching	Removal of oxide layer	8

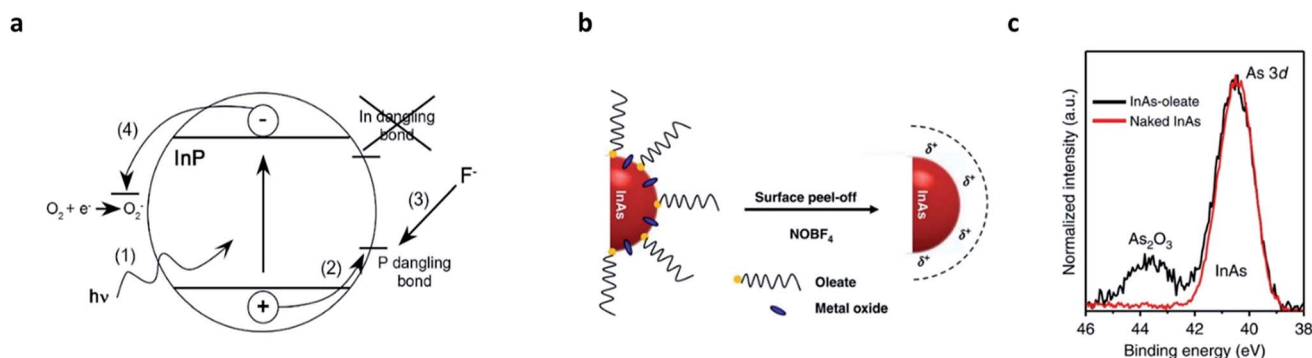


Fig. 4 Surface etching on III–V QDs. (a) Suggested mechanism of HF treatment on InP QDs. The photogenerated hole activates P dangling states and the activated P site is removed by forming PF₃. Oxygen scavenges electrons while holes are consumed at the P site. Reproduced with permission from ref. 41. Copyright 2005 American Institute of Physics. (b) Amorphous oxides, as well as the native ligands, on the surface of InAs QDs can be removed by NOBF₄ etching. (c) 3d XPS patterns for InAs–oleate (black, before the etching) and naked InAs (red, after the etching) show successful removal of oxides. Reproduced with permission from ref. 8. Copyright 2018 Nature Publishing Group.

et al. investigated the coordination of the cation-rich surface and ligands of II–VI, IV–VI, and III–V QDs using the electron-counting model and DFT calculations.⁴⁴ In the case of zinc blende InAs QDs with a tetrahedral bonding nature, the indium atoms in the QDs have three electrons and four bonds, which results in a fractional 0.75 electrons per bond. Accordingly, the As atoms in InAs QDs share five electrons with four bonds, and each As atom shares 1.25 electrons per bond. To passivate the InAs (100) surface, where indium has two dangling bonds with 1.5 electrons (Fig. 6a), two ligands donate three electrons to the dangling bonds. Thus, the surface becomes stable through co-passivation of one carboxylate or halide ligand, which can donate one electron, and one amine ligand, which can donate two electrons (Fig. 6c). Another method for stabilizing the InAs (100) surface involves passivating one monovalent anion ligand after In–In dimerization (Fig. 6b).

The InAs QD (111) surface has 0.75 electrons per dangling bond. Thus, a ligand with 1.25 electrons is required to stabilize the (111) surface of InAs QDs (Fig. 6d). However, there is no ligand that can provide 1.25 electrons under the colloidal QD synthesis conditions. To develop a method for passivating the InAs (111) surface, the (1 × 1) model is changed to a (2 × 2)

model, such that four surface indium atoms have four dangling bonds with three electrons in the (2 × 2) model. To stabilize the (111) surface of InAs QDs in the (2 × 2) model, four ligands with five electrons are needed. To satisfy this requirement, the (111) surface of the InAs QDs must be passivated by three carboxylate or halide ligands, each of which can donate one electron, and one amine ligand, which can donate two electrons (Fig. 6f). These co-passivation methods are very important for stabilizing the surface of III–V QDs because it is more difficult to passivate the surface with only one type of ligand. Evidently, the stabilization energy is 53 meV Å⁻² when passivated with only X-type ligands as shown in Fig. 6e, which is less than half the value (130 meV Å⁻²) of the co-passivation shown in Fig. 6f.⁴⁴

4.3 Well-defined surface in III–V QDs

In spite of such desirable atomistic surface models, it is generally hard to analyze the surface-related characteristics of III–V QDs because of the ease of surface oxidation. Large oxophilicity of group III and V elements causes oxidation during and after the synthesis.⁵⁹ The most commonly used fatty-acid ligands for III–V QD synthesis undergo ketonization reactions and produce H₂O during the reaction at high temperature as follows:

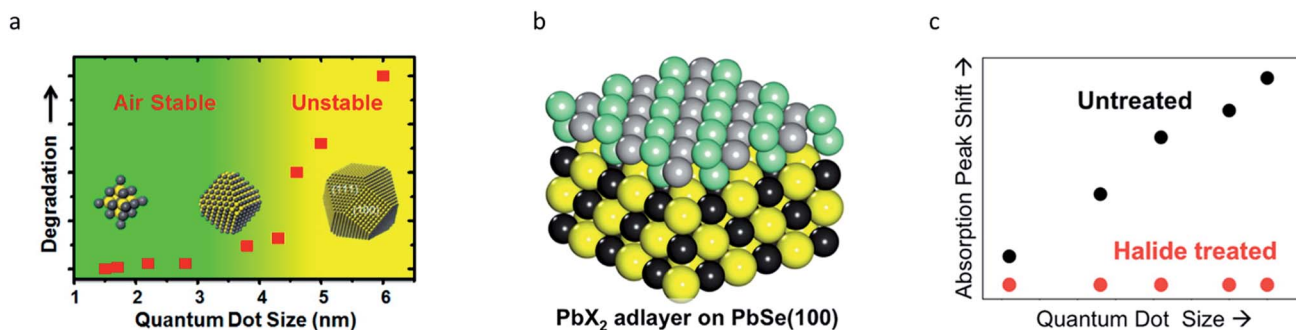


Fig. 5 (a) Air stability of PbS QDs with respect to the diameter, exhibiting a stability transition at ~4 nm due to their facet transition. Reproduced with permission from ref. 19. Copyright 2013 American Chemical Society. (b) Stoichiometric (100) surface of PbSe QDs can be passivated by halides. (c) A significant increase in the stability of PbSe QDs after halide passivation is seen. Reproduced with permission from ref. 20. Copyright 2014 American Chemical Society.

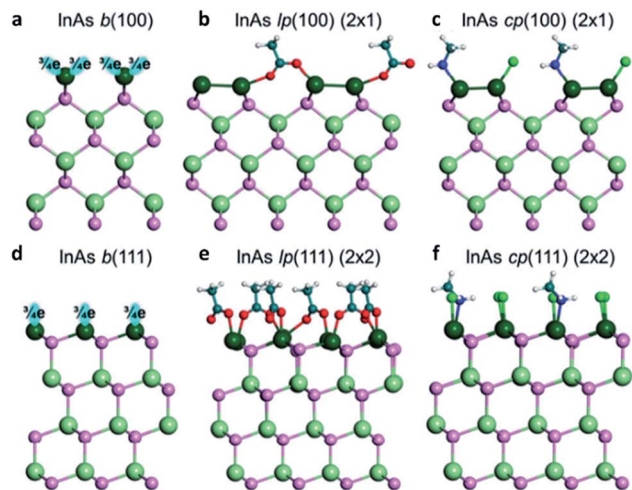


Fig. 6 Atomistic view of the InAs QD (a–c) (100) surface and (d–f) (111) surface. *b* stands for the bare surface, *lp* for ligand passivation, and *cp* for co-passivation. Reproduced with permission from ref. 44. Copyright 2017 Royal Society of Chemistry.



H_2O generated during the reaction oxidizes the III–V QD surfaces,^{61,83} so it is necessary to design a reaction that does not involve ketonization to understand the atomistic surface. Recent extensive investigation on InP clusters prepared at low temperature with defined atomic numbers and concrete view of the surfaces may help to understand the surface chemistry of InP nanocrystals and the surface energy driven synthetic pathways.^{84–87}

Instead of fatty acid ligands, a new synthetic strategy uses indium halide with an amine-based *V* precursor (amino pnictide) as an alternative to $(\text{TMS})_3\text{P}$ with In carboxylates, which is most commonly used in synthesis of InP QDs. The resulting InP QDs do not exhibit an oxidation signal in the P 2p spectrum in XPS analysis.⁸⁸ This method not only avoids surface oxidation during the reaction but also is safer and less expensive than that using $(\text{TMS})_3\text{P}$ with a fatty-acid.

More interestingly, in the synthesis using indium chloride (InCl_3), aminophosphine in oleylamine can provide well-passivated fractional dangling bonds of the (111) facets of the zinc blende structure of III–V QDs. For example, one amine, which can give two electrons, and three chlorine that can give one electron can stabilize the (111) surface of InP, which requires 5 electrons in (2×2) surface indium atoms. As a result, tetrahedron shaped InP QDs with only the (111) facet can be synthesized (Fig. 7a).⁸⁸ This was the first demonstration in which the shape of III–V QDs was precisely controlled in colloidal synthesis, with the exception of solution–liquid–solid methods that use the catalyst to control the growth direction.^{89,90} Subsequently, tetrahedron shaped InAs QDs were synthesized using InCl_3 , aminoarsine, and oleylamine by Talapin *et al.* (Fig. 7b).⁹¹

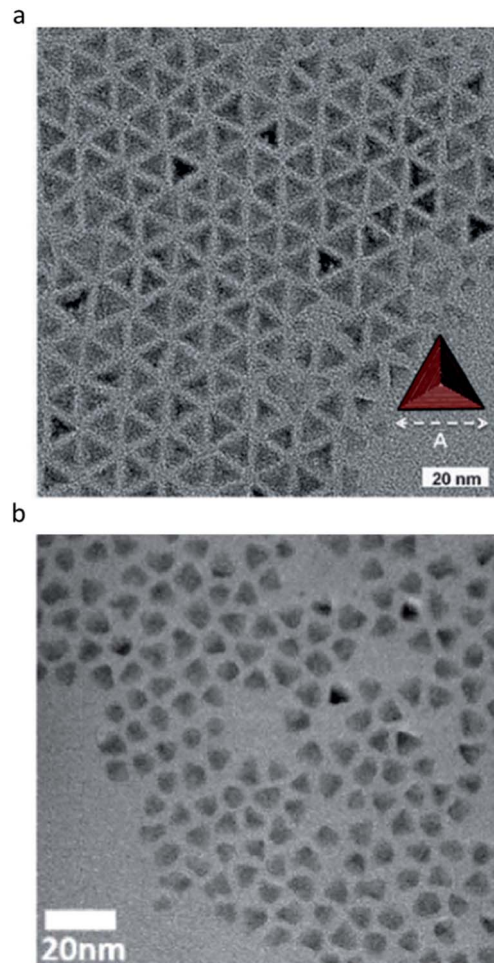


Fig. 7 Tetrahedrally shaped III–V QDs. (a) InP QDs with the (111) facets exposed. Reproduced with permission from ref. 88. Copyright 2016 Wiley Online Library. (b) InAs QDs with the (111) facets exposed. Reproduced with permission from ref. 91. Copyright 2016 ACS Publications.

Through these results, control of the surface energy based on the electron counting model effectively stabilizes the specific facets of III–V QDs. Furthermore, we expect that QDs with desired facets will be controlled by this method. Well-defined facets of QDs are highly desired tools for use in further research, such as facet specific surface–ligand interactions, reactivity, stability, and optoelectronic properties.

5. Summary and outlook

In this perspective, we discuss the problem of deep trap states expressed mainly by the covalent surfaces of III–V QDs. Deep traps in III–V QDs reduce the performance of the materials and severely limit their use in various applications. Therefore, eliminating surface defects is central to III–V QD research.

Approaches for deep trap passivation of III–V QDs include removing deep traps *via* shelling, dangling bond etching, and post-synthetic ligand treatment. While success has been reported to an extent, to design a better chemistry for deep trap

passivation, atomistic understanding on the surface structure is essential. Creating an un-oxidized surface in III-V QDs is the first step for adapting surface study protocols that have been developed extensively for ionic II-VI or IV-VI QDs. More importantly, formation of well-defined facets in III-V QDs will provide a simplified platform to investigate more detailed surface ligand interaction, atomistic interface structures, faceted surface energy driven growth, facet-specific stability, and many more, which are otherwise impossible to quantify because of the complex nature of covalent surfaces.

Conflicts of interest

There are no conflicts to declare.

Acknowledgements

This research was supported by the Creative Materials Discovery Program through the National Research Foundation of Korea (NRF) funded by the Ministry of Science and ICT (MSIT) (2019M3D1A1078296), the NRF grant funded by the MSIT (2019R1A2B5B03070407 and 2018R1A2A2A14079326), and the grant (20173010013200) funded by KETEP and MOTIE and the Global Frontier R&D program of the Center for Multiscale Energy Systems (2017M3A6A7051087).

References

- 1 C.-F. Lai, Y.-C. Tien, H.-C. Tong, C.-Z. Zhong and Y.-C. Lee, *RSC Adv.*, 2018, **8**, 35966–35972.
- 2 K.-H. Lee, C.-Y. Han, H.-D. Kang, H. Ko, C. Lee, J. Lee, N. Myoung, S.-Y. Yim and H. Yang, *ACS Nano*, 2015, **9**, 10941–10949.
- 3 M. Yuan, M. Liu and E. H. Sargent, *Nat. Energy*, 2016, **1**, 16016.
- 4 R. Debnath, O. Bakr and E. H. Sargent, *Energy Environ. Sci.*, 2011, **4**, 4870–4881.
- 5 A. P. Litvin, I. V. Martynenko, F. Purcell-Milton, A. V. Baranov, A. V. Fedorov and Y. K. Gun'ko, *J. Mater. Chem. A*, 2017, **5**, 13252–13275.
- 6 H. Choi, J. H. Song, J. Jang, X. D. Mai, S. Kim and S. Jeong, *Nanoscale*, 2015, **7**, 17473–17481.
- 7 J. H. Song and S. Jeong, *Nano Convergence*, 2017, **4**, 21.
- 8 J. H. Song, H. Choi, H. T. Pham and S. Jeong, *Nat. Commun.*, 2018, **9**, 4267.
- 9 J. H. Song, X. D. Mai, S. Jeong and Y. H. Kim, *J. Phys. Chem. Lett.*, 2017, **8**, 5259–5263.
- 10 J. Li and J. J. Zhu, *Analyst*, 2013, **138**, 2506–2515.
- 11 G. Mandal, M. Darragh, Y. A. Wang and C. D. Heyes, *Chem. Commun.*, 2013, **49**, 624–626.
- 12 I. V. Martynenko, A. P. Litvin, F. Purcell-Milton, A. V. Baranov, A. V. Fedorov and Y. K. Gun'ko, *J. Mater. Chem. B*, 2017, **5**, 6701–6727.
- 13 X. Peng, *Nano Res.*, 2009, **2**, 425–447.
- 14 S. Tamang, C. Lincheneau, Y. Hermans, S. Jeong and P. Reiss, *Chem. Mater.*, 2016, **28**, 2491–2506.
- 15 M. C. Beard and R. J. Ellingson, *Laser Photonics Rev.*, 2008, **2**, 377–399.
- 16 R. D. Schaller, J. M. Pietryga and V. I. Klimov, *Nano Lett.*, 2007, **7**, 3469–3476.
- 17 A. Y. Chang, W. Liu, D. V. Talapin and R. D. Schaller, *ACS Nano*, 2014, **8**, 8513–8519.
- 18 V. I. Klimov, *Appl. Phys. Lett.*, 2006, **89**, 87–90.
- 19 H. Choi, J. H. Ko, Y. H. Kim and S. Jeong, *J. Am. Chem. Soc.*, 2013, **135**, 5278–5281.
- 20 J. Y. Woo, J. H. Ko, J. H. Song, K. Kim, H. Choi, Y. H. Kim, D. C. Lee and S. Jeong, *J. Am. Chem. Soc.*, 2014, **136**, 8883–8886.
- 21 J. Y. Woo, S. Lee, S. Lee, W. D. Kim, K. Lee, K. Kim, H. J. An, D. C. Lee and S. Jeong, *J. Am. Chem. Soc.*, 2016, **138**, 876–883.
- 22 A. J. Houtepen, Z. Hens, J. S. Owen and I. Infante, *Chem. Mater.*, 2017, **29**, 752–761.
- 23 C. Giansante and I. Infante, *J. Phys. Chem. Lett.*, 2017, **8**, 5209–5215.
- 24 L. E. Brus, *J. Chem. Phys.*, 1984, **80**, 4403.
- 25 P. R. Brown, D. Kim, R. R. Lunt, N. Zhao, M. G. Bawendi, J. C. Grossman and V. Bulović, *ACS Nano*, 2014, **8**, 5863–5872.
- 26 D. M. Kroupa, M. Vörös, N. P. Brawand, B. W. McNichols, E. M. Miller, J. Gu, A. J. Nozik, A. Sellinger, G. Galli and M. C. Beard, *Nat. Commun.*, 2017, **8**, 15257.
- 27 K. A. Jackson and W. Schroter, *Handbook of Semiconductor Technology: electronic structure and properties of semiconductors*, WILEY-VCH, Verlag GmbH, D-69469 Weinheim (Federal Republic of Germany), 2000.
- 28 K. Seeger, *Semiconductor Physics*, Springer, Berlin, Heidelberg, 2004.
- 29 S. V. Gaponenko and H. V. Demir, *Applied Nanophotonics*, Cambridge University Press, 2018.
- 30 B. D. Pelatt, R. Ravichandran, J. F. Wager and D. A. Keszler, *J. Am. Chem. Soc.*, 2011, **133**, 16852–16860.
- 31 C. Kittel, *Introduction to solid state physics*, Hoboken, NJ, United States, 8th edn, 2005.
- 32 S. Z. Karazhanov, *Semiconductors*, 2005, **39**, 161.
- 33 M. Hass and B. W. Hennis, *J. Phys. Chem. Solids*, 1962, **23**, 1099–1104.
- 34 S. Tamang, S. Lee, H. Choi and S. Jeong, *Chem. Mater.*, 2016, **28**, 8119–8122.
- 35 S. Tamang, K. Kim, H. Choi, Y. Kim and S. Jeong, *Dalton Trans.*, 2015, **44**, 16923–16928.
- 36 D. C. Gary, A. Petrone, X. Li and B. M. Cossairt, *Chem. Commun.*, 2017, **53**, 161–164.
- 37 P. Ramasamy, K. J. Ko, J. W. Kang and J. S. Lee, *Chem. Mater.*, 2018, **30**, 3643–3647.
- 38 J. R. Heath, *Chem. Soc. Rev.*, 1998, **27**, 65.
- 39 H. Fu and A. Zunger, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 1997, **56**, 1496–1508.
- 40 P. Reiss, M. Protière and L. Li, *Small*, 2009, **5**, 154–168.
- 41 S. Adam, D. V. Talapin, H. Borchert, A. Lobo, C. McGinley, A. R. B. de Castro, M. Haase, H. Weller and T. Möller, *J. Chem. Phys.*, 2005, **123**, 084706.
- 42 N. Kirkwood, J. O. V. V. Monchen, R. W. Crisp, G. Grimaldi, H. A. C. Bergstein, I. du Fossé, W. van der Stam, I. Infante

- and A. J. Houtepen, *J. Am. Chem. Soc.*, 2018, **140**, 15712–15723.
- 43 J. L. Stein, E. A. Mader and B. M. Cossairt, *J. Phys. Chem. Lett.*, 2016, **7**, 1315–1320.
- 44 J.-H. Ko, D. Yoo and Y.-H. Kim, *Chem. Commun.*, 2017, **53**, 388–391.
- 45 P. Reiss, M. Carrière, C. Lincheneau, L. Vaure, S. Tamang, M. Carrière, C. Lincheneau, L. Vaure and S. Tamang, *Chem. Rev.*, 2016, **116**, 10731–10819.
- 46 S. Adachi, *Properties of Semiconductor Alloys: Group-IV, III–V and II–VI Semiconductors*, John Wiley & Sons, Ltd, Hoboken, NJ, United States, 2009.
- 47 P. Waltereit, O. Brandt, A. Trampert, H. T. Grahn, J. Menniger, M. Ramsteiner, M. Reiche and K. H. Ploog, *Nature*, 2000, **406**, 865–868.
- 48 The National Renewable Energy Laboratory (NREL), *Best Research-Cell Efficiency Chart*, <https://www.nrel.gov/pv/cell-efficiency.html>, accessed, 11 July 2019.
- 49 A. C. Jones, *Chem. Soc. Rev.*, 2004, **26**, 101.
- 50 D. C. Gary, B. a. Glassy and B. M. Cossairt, *Chem. Mater.*, 2014, **26**, 1734–1744.
- 51 D. Franke, D. K. Harris, L. Xie, K. F. Jensen and M. G. Bawendi, *Angew. Chem., Int. Ed.*, 2015, **54**, 14299–14303.
- 52 D. Hahm, D. Ko, B. G. G. Jeong, S. Jeong, J. Lim, W. K. K. Bae, C. Lee and K. Char, *J. Inf. Disp.*, 2019, **20**, 61–72.
- 53 J. Park, J. Joo, G. K. Soon, Y. Jang and T. Hyeon, *Angew. Chem., Int. Ed.*, 2007, **46**, 4630–4660.
- 54 S. G. Kwon and T. Hyeon, *Small*, 2011, **7**, 2685–2702.
- 55 M. S. Daw and D. L. Smith, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 1979, **20**, 5150–5156.
- 56 E. Cho, T. Kim, S. Choi, H. Jang, K. Min and E. Jang, *ACS Appl. Nano Mater.*, 2018, **1**, 7106–7114.
- 57 J. Jasieniak, M. Califano and S. E. Watkins, *ACS Nano*, 2011, **5**, 5888–5902.
- 58 V. Srivastava, W. Liu, E. M. Janke, V. Kamysbayev, A. S. Filatov, C. J. Sun, B. Lee, T. Rajh, R. D. Schaller and D. V. Talapin, *Nano Lett.*, 2017, **17**, 2094–2101.
- 59 K. P. Kepp, *Inorg. Chem.*, 2016, **55**, 9461–9470.
- 60 M. D. Tessier, E. A. Baquero, D. Dupont, V. Grigel, E. Bladt, S. Bals, Y. Coppel, Z. Hens, C. Nayral and F. Delpech, *Chem. Mater.*, 2018, **30**, 6877–6883.
- 61 A. Cros-Gagneux, F. Delpech, C. Nayral, A. Cornejo, Y. Coppel and B. Chaudret, *J. Am. Chem. Soc.*, 2010, **132**, 18147–18157.
- 62 M. A. A. Hines and P. Guyot-Sionnest, *J. Phys. Chem.*, 1996, **100**, 468–471.
- 63 J. Lim, B. G. Jeong, M. Park, J. K. Kim, J. M. Pietryga, Y.-S. Park, V. I. Klimov, C. Lee, D. C. Lee and W. K. Bae, *Adv. Mater.*, 2014, **26**, 8034–8040.
- 64 J. Lim, Y.-S. Park, K. Wu, H. J. Yun and V. I. I. Klimov, *Nano Lett.*, 2018, **18**, 6645–6653.
- 65 J. Lim, Y.-S. Park and V. I. Klimov, *Nat. Mater.*, 2018, **17**, 42–49.
- 66 Y.-S. Park, J. Lim and V. I. Klimov, *Nat. Mater.*, 2019, **18**, 249–255.
- 67 W. K. Bae, L. A. Padilha, Y.-S. Park, H. McDaniel, I. Robel, J. M. Pietryga and V. I. I. Klimov, *ACS Nano*, 2013, **7**, 3411–3419.
- 68 J. Lim, M. Park, W. K. Bae, D. Lee, S. Lee, C. Lee and K. Char, *ACS Nano*, 2013, **7**, 9019–9026.
- 69 S. Kim, T. Kim, M. Kang, S. K. Kwak, T. W. Yoo, L. S. Park, I. Yang, S. Hwang, J. E. Lee, S. K. Kim and S.-W. Kim, *J. Am. Chem. Soc.*, 2012, **134**, 3804–3809.
- 70 S. Haubold, M. Haase, A. Kornowski and H. Weller, *ChemPhysChem*, 2001, **2**, 331–334.
- 71 L. Li and P. Reiss, *J. Am. Chem. Soc.*, 2008, **130**, 11588–11589.
- 72 H. C. Wang, H. Zhang, H. Y. Chen, H. C. Yeh, M. R. Tseng, R. J. Chung, S. Chen and R. S. Liu, *Small*, 2017, **13**, 1603962.
- 73 J. Lim, W. K. Bae, D. Lee, M. K. Nam, J. Jung, C. Lee, K. Char and S. Lee, *Chem. Mater.*, 2011, 4459–4463.
- 74 D. Hahm, J. H. Chang, B. G. Jeong, P. Park, J. Kim, S. Lee, J. Choi, W. D. Kim, S. Rhee, J. Lim, D. C. Lee, C. Lee, K. Char and W. K. Bae, *Chem. Mater.*, 2019, **31**, 3476–3484.
- 75 D. V. Talapin, N. Gaponik, H. Borchert, A. L. Rogach, M. Haase and H. Weller, *J. Phys. Chem. B*, 2002, **106**, 12659–12663.
- 76 D. D. Lovingood and G. F. Strouse, *Nano Lett.*, 2008, **8**, 3394–3397.
- 77 O. I. Micic, J. Sprague, Z. Lu and A. J. Nozik, *Appl. Phys.*, 1996, **68**, 3150–3152.
- 78 T. G. Kim, D. Zhrebetsky, Y. Bekenstein, M. H. Oh, L. W. Wang, E. Jang and A. P. Alivisatos, *ACS Nano*, 2018, **12**, 11529–11540.
- 79 M. A. Boles, D. Ling, T. Hyeon and D. V. Talapin, *Nat. Mater.*, 2016, **15**, 141–154.
- 80 J. H. Song, H. Choi, Y.-H. H. Kim and S. Jeong, *Adv. Energy Mater.*, 2017, **7**, 1–6.
- 81 G. H. Carey, A. L. Abdelhady, Z. Ning, S. M. Thon, O. M. Bakr and E. H. Sargent, *Chem. Rev.*, 2015, **115**, 12732–12763.
- 82 C. Schliehe, B. H. Juarez, M. Pelletier, S. Jander, D. Greshnykh, M. Nagel, A. Meyer, S. Foerster, A. Kornowski, C. Klinke and H. Weller, *Science*, 2010, **329**, 550–553.
- 83 L. Xie, D. K. Harris, M. G. Bawendi and K. F. Jensen, *Chem. Mater.*, 2015, **27**, 5058–5063.
- 84 D. C. Gary, M. W. Terban, S. J. L. Billinge and B. M. Cossairt, *Chem. Mater.*, 2015, **27**, 1432–1441.
- 85 D. C. Gary, S. E. Flowers, W. Kaminsky, A. Petrone, X. Li and B. M. Cossairt, *J. Am. Chem. Soc.*, 2016, **138**, 1510–1513.
- 86 Q. Zhao and H. J. Kulik, *Chem. Mater.*, 2018, **30**, 7154–7165.
- 87 A. Ritchhart and B. M. Cossairt, *Inorg. Chem.*, 2019, **58**, 2840–2847.
- 88 K. Kim, D. Yoo, H. Choi, S. Tamang, J. Ko, S. Kim, Y. Kim and S. Jeong, *Angew. Chem.*, 2016, **55**, 1–6.
- 89 F. Wang, A. Dong and W. E. Buhro, *Chem. Rev.*, 2016, **116**, 10888–10933.
- 90 S. Kan, A. Aharoni, T. Mokari and U. Banin, *Faraday Discuss.*, 2004, **125**, 23–38.
- 91 V. Srivastava, E. M. Janke, B. T. Diroll, R. D. Schaller and D. V. Talapin, *Chem. Mater.*, 2016, **28**, 6797–6802.